6 to 42 V

TPS54561-Q1

5 V @ 4 A
Fs = 2 MHz

TPS57114-Q1

Vcore 1.425 V @ 4 A
Fs = 2 MHz

LM26420-Q1

I/O 3.3 V @ 1.5 A
Fs = 2 MHz

I/O 1.8 V @ 1 A
Fs = 2 MHz

TPS54388-Q1

DDR3 1.5 V @ 3 A
Fs = 2 MHz

TLV70030-Q1

VDD_HIGH_IN
VDD_SNVS_IN
3.0 V @ 0.15 A
**Label Table**

<table>
<thead>
<tr>
<th>Variant</th>
<th>Label Text</th>
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</thead>
<tbody>
<tr>
<td>001</td>
<td>PMP4442-01, E2</td>
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</table>

**Assembly Notes**

- ZZ1: Not necessary for all PCB labels only.
- ZZ2: These assemblies are ESD sensitive. ESD precautions shall be observed.
- ZZ3: These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.
- ZZ4: These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.
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